2SC4420

Silicon NPN triple diffusion planar type

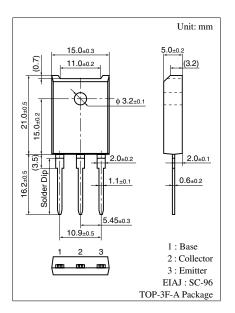
For high breakdown voltage high-speed switching

■ Features

- High-speed switching
- \bullet High collector to base voltage V_{CBO}
- Wide area of safe operation (ASO)
- ullet Satisfactory linearity of forward current transfer ratio h_{FE}
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter		Symbol	Rating	Unit
Collector to base voltage		V_{CBO}	900	V
Collector to emitter voltage		V _{CES}	900	V
		V _{CEO}	800	V
Emitter to base voltage		V_{EBO}	7	V
Peak collector current		I_{CP}	5	A
Collector current		I_{C}	3	A
Base current		I_B	1	A
Collector power	$T_C = 25^{\circ}C$	$P_{\rm C}$	70	W
dissipation	$T_a = 25^{\circ}C$		3	
Junction temperature		T _j	150	°C
Storage temperature		T_{stg}	-55 to +150	°C

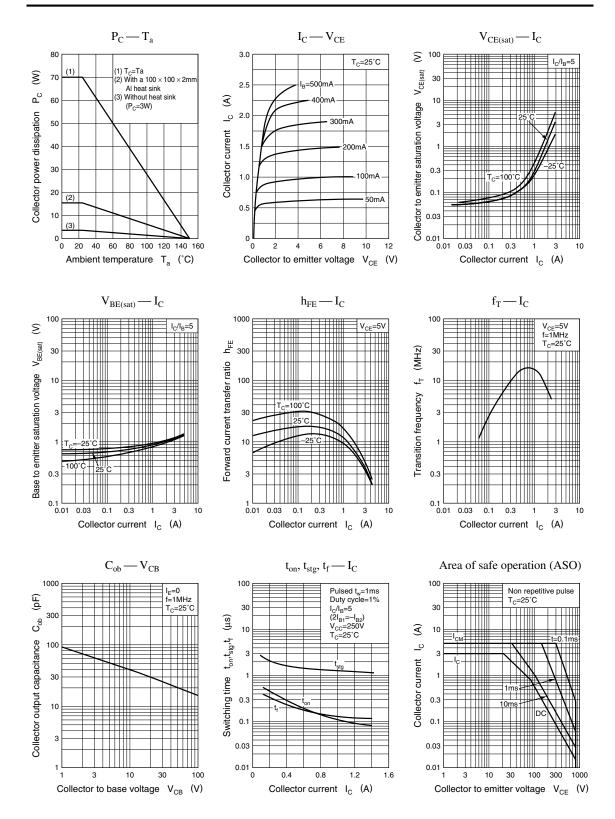


■ Electrical Characteristics $T_C = 25$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 900 \text{ V}, I_E = 0$			50	μΑ
Emitter cutoff current	I_{EBO}	$V_{EB} = 7 \text{ V}, I_{C} = 0$			50	μΑ
Collector to emitter voltage	V_{CEO}	$I_C = 10 \text{ mA}, I_B = 0$	800			V
Forward current transfer ratio	h_{FE1}	$V_{CE} = 5 \text{ V}, I_{C} = 0.1 \text{ A}$	8			
	h _{FE2}	$V_{CE} = 5 \text{ V}, I_{C} = 0.8 \text{ A}$	6			
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 0.8 \text{ A}, I_B = 0.16 \text{ A}$			1.5	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_C = 0.8 \text{ A}, I_B = 0.16 \text{ A}$			1.5	V
Transition frequency	f_T	$V_{CE} = 5 \text{ V}, I_{C} = 0.15 \text{ A}, f = 1 \text{ MHz}$		10		MHz
Turn-on time	t _{on}	$I_C = 0.8 \text{ A}, I_{B1} = 0.16 \text{ A}, I_{B2} = -0.32 \text{ A},$			0.7	μs
Storage time	t _{stg}	$V_{CC} = 250 \text{ V}$			2.5	μs
Fall time	t_{f}				0.3	μs

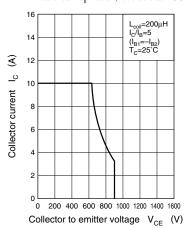
Panasonic 1

2SC4420 Power Transistors

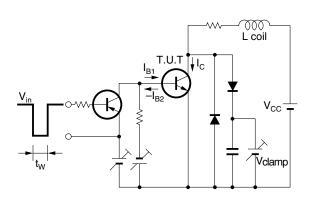


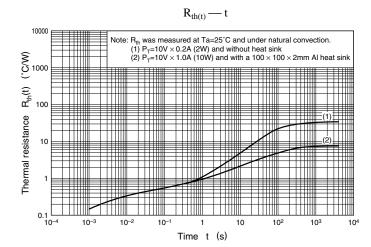
Power Transistors 2SC4420

Area of safe operation, reverse bias ASO



Reverse bias ASO measuring circuit





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